rivers



# CGS2535V/CGS2535TV Commercial Quad 1 to 4 Clock Drivers/Industrial Quad 1 to 4 Clock Drivers

### **General Description**

These Clock Generation and Support clock drivers are specifically designed for driving memory arrays requiring large fanouts while operating at high speeds.

The CGS2535 is a non-inverting 4 to 16 driver with CMOS I/O structures. The CGS2535 specification guarantees part-to-part skew variation.

#### **Features**

- Guaranteed:
  - 1.0 ns rise and fall times while driving 12 inches of 50  $\!\Omega$  microstrip terminated with 25 pF

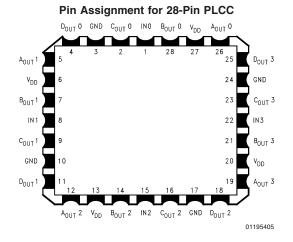
- 350 ps pin-to-pin skew ( $t_{OSLH}$  and  $t_{OSHL}$ )
- 650 ps part-to-part variation on positive or negative transition @ 5V V<sub>CC</sub>
- Operates with either 3.3V or 5.0V supply
- Inputs 5V tolerant with V<sub>CC</sub> in 3.3V range
- Symmetric output current drive: 24 mA I<sub>OH</sub>/I<sub>OL</sub>
- Industrial temperature range -40°C to +85°C
- Symmetric package orientation
- Large fanout for memory driving applications
- Guaranteed 2 kV ESD protection
- Implemented on National's ABT family process
- 28-pin PLCC for optimum skew performance

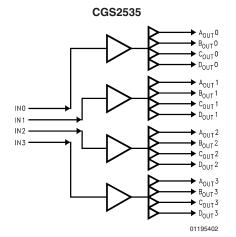
# **Ordering Information**

Order Number	Package Number	Package Description	Γ
CGS2535V	V28A	28-Lead Molded Plastic Leaded Chip Carrier	Γ
CGS2535TV			

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the order number.

# **Connection Diagrams**





#### **Truth Table**

Input	Output
In (0-3)	ABCD Out (0-3)

# **Absolute Maximum Ratings** (Note 1)

Current Applied to Output

(High/Low) Twice the Rated

 $I_{OH}/I_{OL}$ 

Operating Temp. Industrial grade  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  Comm. grade  $0^{\circ}\text{C}$  to  $+70^{\circ}\text{C}$ 

Storage Temperature Range  $-65^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$ Airflow Typical  $\theta_{\text{JA}}$ 

0 LFM 62°C/W 225 LFM 43°C/W

500 LFM 34°C/W

900 LFM 27°C/W

# Recommended Operating Conditions

Supply Voltage  $V_{\rm CC}$  4.75V to 5.25V  $V_{\rm CC}$  3.0V to 3.6V

Maximum Input Rise/Fall Time

(0.8V to 2.0V) 5 ns

Free Air Operating Temperature

Commercial  $0^{\circ}\text{C to} + 70^{\circ}\text{C}$ Industrial  $-40^{\circ}\text{C to} + 85^{\circ}\text{C}$ 

**Note 1:** The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the DC and AC Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The Recommended Operating Conditions will define the conditions for actual device operation.

#### **DC Electrical Characteristics**

Over recommended operating free air temperature range. All typical values are measured at  $V_{CC}$  = 5V,  $T_A$  = 25°C.

Symbol	Parameter	Conditions	V <sub>cc</sub> (V)	Min	Тур	Max	Units
V <sub>IH</sub>	Input High Level Voltage		3.0	2.1			V
			4.5	3.15			
			5.5	3.85			
V <sub>IL</sub>	Input Low Level Voltage		3.0			0.9	V
			4.5			1.35	
			5.5			1.65	
V <sub>IK</sub>	Input Clamp Voltage	$I_1 = -18 \text{ mA}$	4.5			-1.2	V
V <sub>OH</sub>	High Level Output Voltage	I <sub>OH</sub> = -50 μA	3.0	2.9			V
			4.5	4.4			
			5.5	5.4			
		$I_{OH} = -24 \text{ mA}$	3.0	2.46			V
			4.5	3.76			
			5.5	4.76			
V <sub>OL</sub>	Low Level Output Voltage	I <sub>OL</sub> = 50 μA	3.0			0.1	V
			4.5			0.1	
			5.5			0.1	
		I <sub>OL</sub> = 24 mA	3.0			0.44	V
			4.5			0.44	
			5.5			0.44	
I <sub>I</sub>	Input Current @ Max Input Voltage	V <sub>IH</sub> = 7V	5.5			7	μΑ
		$V_{IH} = V_{CC}$	3.6			1	
I <sub>IH</sub>	High Level Input Current	$V_{IH} = V_{CC}$	5.5			5	μΑ
I <sub>IL</sub>	Low Level Input Current	V <sub>IL</sub> = 0V	5.5	-5			μΑ
I <sub>OLD</sub>	Minimum Dynamic Output Current	$V_{OLD} = 1.65V \text{ (max)}$	5.5	75			mA
	(Note 2)	$V_{OLD} = 0.9V \text{ (max)}$	3.0 (Note 3)	36			
I <sub>OHD</sub>	Minimum Dynamic Output Current	V <sub>OHD</sub> = 3.85V (min)	5.5	-75			mA
	(Note 2)	V <sub>OHD</sub> = 2.1V (min)	3.0 (Note 3)	-25			
I <sub>cc</sub>	Supply Current		3.6			75	μΑ
			5.5			235	
C <sub>IN</sub>	Input Capacitance		5.0		5		pF

Note 2: Maximum test duration 2.0 ms, one output loaded at a time.

Note 3: At  $V_{CC} = 3.3V$ ,  $I_{OLD} = 55$  mA min; @  $V_{CC} = 3.6V$ ,  $I_{OLD} = 64$  mA min

At  $V_{CC} = 3.3V$ ,  $I_{OHD} = -58$  mA min; @  $V_{CC} = 3.6V$ ,  $I_{OHD} = -66$  mA min

www.national.com 2

# **AC Electrical Characteristics** (Notes 4, 5, 6)

Over recommended operating free air temperature specified. All typical values are measured at  $V_{CC}$  = 5V,  $T_A$  = 25°C.

		V <sub>cc</sub> (V) (Note 11)	CGS2535						
			$T_A = +25^{\circ}C$ $T_A = -$				-40°C to +85°C		Units
Symbol	pol Parameter		$C_L = 50 \text{ pF}, R_L = 500\Omega$			(Note 7) C <sub>L</sub> = <b>50 pF</b> , R <sub>L</sub> = <b>500</b> Ω			
			Min	Тур	Max	Min	Тур	Max	
f <sub>max</sub>	Frequency Maximum	3.0					100		MHz
		5.0					125		
t <sub>PLH</sub>	Low-to-High Propagation Delay	3.3			4.5	2.5		4.5	ns
	CK to O <sub>n</sub> @ 1 MHz (Note 13)	5.0			3.5	2.0		3.5	
t <sub>PHL</sub>	High-to-Low Propagation Delay	3.3			4.5	2.5		4.5	ns
	CK to O <sub>n</sub> @ 1 MHz (Note 13)	5.0			3.5	2.0		3.5	
t <sub>PLH</sub>	Low-to-High Propagation Delay	3.3			5.0	2.5		5.0	ns
	CK to O <sub>n</sub> @ 66.67 MHz (Note 13) (Note	5.0			4.5	2.0		4.5	
	14)								
t <sub>PHL</sub>	High-to-Low Propagation Delay	3.3			5.0	2.5		5.0	ns
	CK to O <sub>n</sub> @ 66.67 MHz (Note 13) (Note	5.0			4.5	2.0		4.5	
	14)								
t <sub>OSLH</sub>	Maximum Skew Common Edge	3.3		150	350		300	350	ps
	Output-to-Output Variation	5.0		150	350		300	350	
	(Note 4) (Note 6)								
t <sub>OSHL</sub>	Maximum Skew Common Edge	3.3		150	350		300	350	ps
	Output-to-Output Variation	5.0		150	350		300	350	
	(Note 4) (Note 6)								
t <sub>rise</sub> ,	Rise/Fall Time	3.3			3.5			3.5	ns
t <sub>fall</sub>	(from 0.8V/2.0V to 2.0V/0.8V) (Note 8)	5.0			3.0			3.0	
t <sub>rise</sub> ,	Rise/Fall Time	3.3			0.8			1.0	ns
t <sub>fall</sub>	(from 0.8V/2.0V to 2.0V/0.8V) (Note 9)	5.0			0.4			0.6	
	(Note 14)								
t <sub>rise</sub> ,	Rise/Fall Time	3.3			1.0			1.0	ns
$t_{\text{fall}}$	(from 0.8V/2.0V to 2.0V/0.8V) (Note 10)	5.0			0.7			0.9	
	(Note 14)								
$t_{High}$	Pulse Width Duration High	3.3	4.0			4.0			ns
	(Note 5) (Note 6) (Note 14)	5.0	4.0			4.0			
$t_{Low}$	Pulse Width Duration Low	3.3	4.0			4.0			
	(Note 5) (Note 6) (Note 14)	5.0	4.0			4.0			
t <sub>PVLH</sub>	Part-to-Part Variation of	3.3			650			1.0	ns
	Low-to-High Transitions	5.0			650			650	ps
	@ 1 MHz (Note 13)								
t <sub>PVHL</sub>	Part-to-Part Variation of	3.3			650			1.0	ns
	High-to-Low Transitions	5.0			650			650	ps
	@ 1 MHz (Note 13)								
t <sub>PVLH</sub>	Part-to-Part Variation of	3.3			1.0			1.0	
	Low-to-High Transitions	5.0			1.0			1.0	
	@ 66.67 MHz (Note 13) (Note 14)								
t <sub>PVHL</sub>	Part-to-Part Variation of	3.3			1.0			1.0	ns
	High-to-Low Transitions	5.0			1.0			1.0	
	@ 66.67 MHz (Note 13) (Note 14)								

Note 4: Output-to-Output Skew is defined as the absolute value of the difference between the actual propagation delay for any outputs within the same packaged device and output bank. The specifications apply to any outputs switching in the same direction either LOW to HIGH (toSLH) or HIGH to LOW (toSHL).

Note 5: Time high is measured with outputs at 2.0V or above. Time low is measured with outputs at 0.8V or below. Input waveform characteristics for  $t_{\text{High}}$ ,  $t_{\text{Low}}$  measurement: f = 66.67 MHz, duty cycle = 50%.

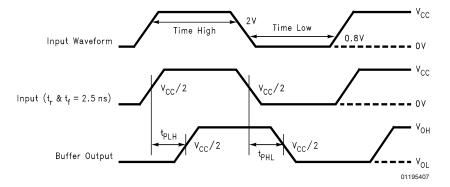
#### AC Electrical Characteristics (Notes 4, 5, 6) (Continued)

- Note 6: The input waveform has a rise and fall time transition time of 2.5 ns (10% to 90%).
- Note 7: Industrial range (-40°C to +85°C) limits apply to the commercial temperature range (0°C to +70°C).
- Note 8: These Rise and Fall times are measured with  $C_L$  = 50 pF,  $R_L$  = 500 $\Omega$  (see *Figure 1*).
- Note 9: These Rise and Fall times are measured with  $C_L = 25 \text{ pF}$ ,  $R_L = 500\Omega$  (see Figure 1), and are guaranteed by design.

Note 10: These Rise and Fall times are measured driving 12 inches of  $50\Omega$  microstrip terminated with equivalent  $C_L = 25$  pF (see Figure 2), and are guaranteed by design.

- Note 11: Voltage Range 5.0 is 5.0V  $\pm$  0.25V, 3.3 is 3.3V  $\pm$  0.3V.
- Note 12: For increased output drive, output pins may be connected together when the corresponding input pins are connected together.
- Note 13: All 16 outputs switching simultaneously.
- Note 14: Guaranteed by design.

# **Timing Information**



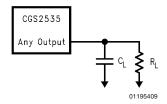


FIGURE 1. A.C. Load (Notes 8, 9)
C<sub>L</sub> = Total Load Including Probes

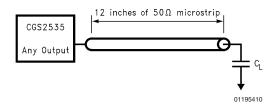


FIGURE 2. A.C. Load (Note 10)

C<sub>L</sub> = Total Load Including Probes

#### CGS2534/35/36/37

#### **MEMORY ARRAY DRIVING**

In order to minimize the total load on the address bus, quite often memory arrays are driven by buffers while having the inputs of the buffers tied together. Although this practice was feasible in the conventional memory designs, in today's high speed, large buswidth designs which require address fetching at higher speeds, this technique produces many undesired results such as cross-talk and over/undershoot.

CGS2534/35/36/37 Quad 1 to 4 clock drivers were designed specifically to address these application issues on high speed, large memory arrays systems.

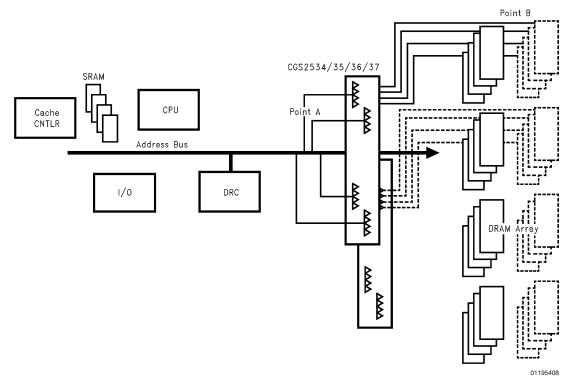
These drivers are optimized to drive large loads, with 3.5 ns propagation delays. These drivers produce less noise while reducing the total capacitive loading on the address bus by having only four inputs tied together (see the diagram below, point A). This helps to minimize the overshoot and undershoot by having only four outputs being switched simultaneously.

Also this larger fan-out helps to save board space since for every one of these drivers, two conventional buffers were typically being used.

Another feature associated with these clock drivers is a 350 ps pin-to-pin skew specification. The minimum skew specification allows high speed memory system designers to optimize the performance of their memory sub-system by operating at higher frequencies without having concerns about output-to-output (bank-to-bank) synchronization problems which are associated with driving high capacitive loads (Point B).

The diagram below depicts a "2534/35/36/37" a memory subsystem operating at high speed with large memory capacity. The address bus is common to both the memory and the CPU and I/Os.

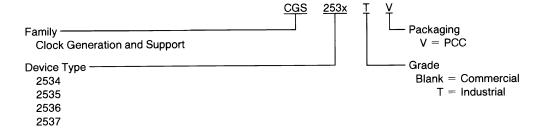
These drivers can operate beyond 125 MHz, and are also available in 3V-5V TTL/CMOS versions with large current drive .



Device	V <sub>cc</sub>	I/O	Output Configuration
2534	5	TTL	Inverting quad 1-4
2535	3 or 5	CMOS	Non-inverting quad 1-4
2536	3 or 5	CMOS	Inverting, Non-inverting, ÷2
2537	5	TTL	Inverting quad 1-4 with series $8\Omega$ output resistors

5 www.national.com

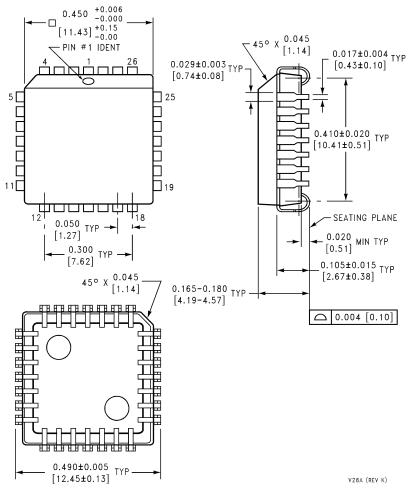
# **Ordering Information**



01195411

www.national.com

#### Physical Dimensions inches (millimeters) unless otherwise noted



28-Lead Molded Plastic Leaded Chip Carrier NS Package Number V28A

#### LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



National Semiconductor Americas Customer Support Center Email: new.feedback@nsc.com

Email: new.feedback@ns

www.national.com

National Semiconductor Europe Customer Support Center Fax: +49 (0) 180-530 85 86

Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 69 9508 6208
English Tel: +44 (0) 870 24 0 2171
Français Tel: +33 (0) 1 41 91 8790

National Semiconductor
Asia Pacific Customer
Support Center
Fax: 65-6250 4466
Email: an support@necessor

Email: ap.support@nsc.com Tel: 65-6254 4466 National Semiconductor Japan Customer Support Center Fax: 81-3-5639-7507 Email: nsj.crc@jksmtp.nsc.com Tel: 81-3-5639-7560